



ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

PRODUCT APPLICATIONS

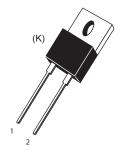
- Anti-Parallel Diode
 - -Switchmode Power Supply -Inverters
- Free Wheeling Diode
 - -Motor Controllers
 - -Converters
 - -Inverters
- · Snubber Diode
- PFC

PRODUCT FEATURES

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- · Popular TO-220 Package
- · Low Forward Voltage
- · Low Leakage Current
- Avalanche Energy Rated

PRODUCT BENEFITS

- Low Losses
- · Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density





- 1 Cathode
- 2 Anode **Back of Case - Cathode**

MAXIMUM RATINGS

All Ratings: $T_C = 25$ °C unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT30DQ120K(G)	UNIT
V _R	Maximum D.C. Reverse Voltage		
V _{RRM}	Maximum Peak Repetitive Reverse Voltage	1200	Volts
V _{RWM}	Maximum Working Peak Reverse Voltage		
I _{F(AV)}	Maximum Average Forward Current (T _C = 103°C, Duty Cycle = 0.5)	30	
I _{F(RMS)}	RMS Forward Current (Square wave, 50% duty)	43	Amps
I _{FSM}	Non-Repetitive Forward Surge Current (T _J = 45°C, 8.3ms)	210	
E _{AVL}	Avalanche Energy (1A, 40mH)	20	mJ
T _J ,T _{STG}	Operating and StorageTemperature Range	-55 to 175	oc.
T _L	Lead Temperature for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

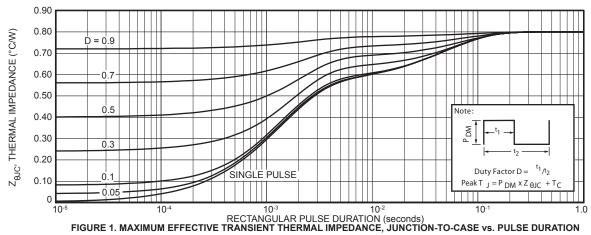
Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
V _F	Forward Voltage	I _F = 30A		2.8	3.3	Volts
		I _F = 60A		3.4		
		I _F = 30A, T _J = 125°C		2.1		
I _{RM}	Maximum Reverse Leakage Current	V _R = 1200V			100	μА
		V _R = 1200V, T _J = 125°C			500	
C _T	Junction Capacitance, V _R = 200V			36		pF

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t _{rr}	Reverse Recovery Time $I_F = 1A$, $di_F/dt =$	se Recovery Time $I_F = 1A$, $di_F/dt = -100A/\mu s$, $V_R = 30V$, $T_J = 25$ °C		26		ns
t _{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -200A/\mu s$ $V_R = 667V$, $T_C = 25^{\circ}C$	-	320		115
Q _{rr}	Reverse Recovery Charge		-	545		nC
I _{RRM}	Maximum Reverse Recovery Current		-	4	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -200A/\mu s$ $V_R = 667V$, $T_C = 125°C$	-	435		ns
Q _{rr}	Reverse Recovery Charge		-	2100		nC
I _{RRM}	Maximum Reverse Recovery Current		-	9	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -1000A/\mu s$ $V_R = 667V$, $T_C = 125°C$	-	180		ns
Q _{rr}	Reverse Recovery Charge		-	2975		nC
I _{RRM}	Maximum Reverse Recovery Current		-	28		Amps

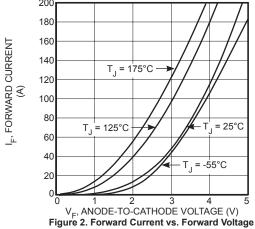
THERMAL AND MECHANICAL CHARACTERISTICS

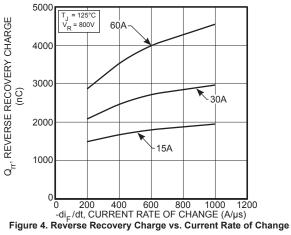
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
R _{øJC}	Junction-to-Case Thermal Resistance			.80	°C/W
W _T	Package Weight		0.07		oz
			1.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

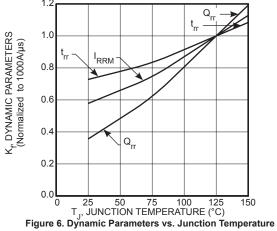
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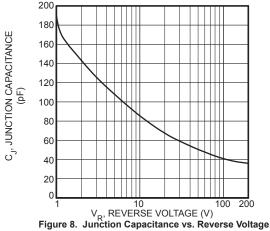


TYPICAL PERFORMANCE CURVES









APT30DQ120K(G)

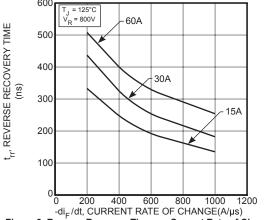
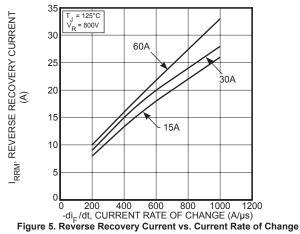


Figure 3. Reverse Recovery Time vs. Current Rate of Change



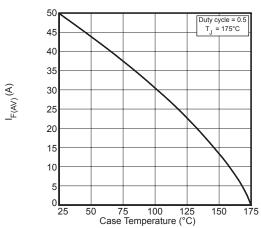


Figure 7. Maximum Average Forward Current vs. CaseTemperature

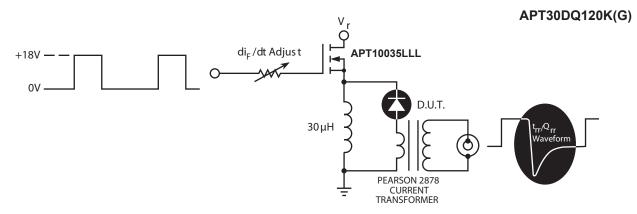


Figure 9. Diode Test Circuit

- 1 I_F Forward Conduction Current
- 2 di_E/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I_{RRM} Maximum Reverse Recovery Current
- 4 t_{rr} Reverse Recovery Time measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and 0.25, I_{RRM} passes through zero.
- $\ensuremath{\mathbf{5}}\xspace \ensuremath{\mathbf{Q}}\xspace_{\ensuremath{\mathsf{r}}}$ Area Under the Curve Defined by $\ensuremath{\mathbf{I}}\xspace_{\ensuremath{\mathsf{RRM}}}$ and $\ensuremath{\mathbf{t}}\xspace_{\ensuremath{\mathsf{RR}}}$

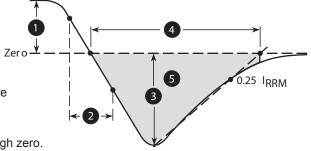
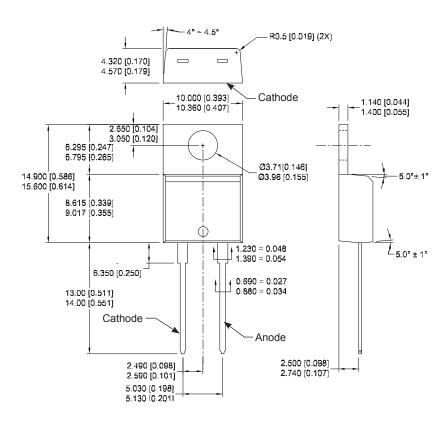


Figure 10. Diode Reverse Recovery Waveform Definition

TO-220 (K) Package Outline e3 100% Sn



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